

NPN Silicon Germanium RF Transistor*

- High gain ultra low noise RF transistor
- Provides outstanding performance for a wide range of wireless applications up to 10 GHz
- Ideal for WLAN and all 5-6 GHz applications
- High OIP₃ and P_{-1dB} for driver stages
- High maximum stable and available gain $G_{\rm ms}$ = 21 dB at 1.8 GHz, $G_{\rm ma}$ = 11.5 dB at 6 GHz
- 150 GHz f_T-Silicon Germanium technology
- Extremly small and flat leadless package, reduced height 0.32 mm max.
- Pb-free (RoHS compliant) package¹⁾
- Qualified according AEC Q101
- * Short term description

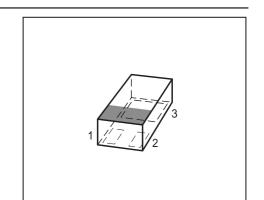




ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pin Configuration			Package	
BFR750L3RH	R8	1=B	2=C	3=E	TSLP-3-9	

¹Pb-containing package may be available upon special request



Unit

K/W

Value

≤ 150



Maximum Ratings

Parameter

Junction - soldering point²⁾

Symbol	Value	Unit
$V_{\sf CEO}$		V
	4	
	3.5	
V _{CES}	13	
	13	
V_{EBO}	1.2	
I _C	90	mA
I _B	9	
P _{tot}	360	mW
T _i	150	°C
T_{A}	-65 150	
	-65 150	
, sig		•
	V _{CES} V _{CBO} V _{EBO} V _C V _{CBO} V _{CB}	V _{CEO} 4 3.5 V _{CES} 13 V _{CBO} 13 V _{EBO} 1.2 I _C 90 I _B 9 P _{tot} 360 T _i 150 T _A -65 150

Symbol

Electrical Characteristics at $T_A = 25$ °C, unless otherwise specified

Parameter	Symbol		Values		Unit
		min.	typ.	max.	
DC Characteristics					
Collector-emitter breakdown voltage	V _{(BR)CEO}	4	4.7	-	V
$I_{\rm C} = 3 \text{ mA}, I_{\rm B} = 0$, ,				
Collector-emitter cutoff current	<i>I</i> CES	-	-	100	μA
$V_{CE} = 13 \text{ V}, V_{BE} = 0$					
Collector-base cutoff current	I _{CBO}	-	-	100	nA
$V_{CB} = 5 \text{ V}, I_{E} = 0$					
Emitter-base cutoff current	/ _{EBO}	-	-	10	μA
$V_{\text{EB}} = 0.5 \text{ V}, I_{\text{C}} = 0$					
DC current gain	h _{FE}	160	250	400	-
$I_{\rm C}$ = 60 mA, $V_{\rm CE}$ = 3 V, pulse measured					

 $^{^1}T_{\mbox{S}}$ is measured on the collector lead at the soldering point to the pcb

²For calculation of R_{thJA} please refer to Application Note Thermal Resistance

 R_{thJS} demanded by P_{tot} and T_{S} , to be fulfilled by design



Electrical Characteristics at $T_{\Delta} = 25^{\circ}\text{C}$, unless otherwise specified

Electrical Characteristics at $T_A = 25$ °C, unless Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics (verified by random sampling	g)				
Transition frequency	f_{T}	-	37	-	GHz
$I_{\rm C} = 60 \text{ mA}, \ V_{\rm CE} = 3 \text{ V}, \ f = 2 \text{ GHz}$					
Collector-base capacitance	C _{cb}	-	0.24	0.42	pF
$V_{\text{CB}} = 3 \text{ V}, f = 1 \text{ MHz}, \text{ emitter grounded}$					
Collector emitter capacitance	C _{ce}	-	0.31	-	
$V_{CE} = 3 \text{ V}, f = 1 \text{ MHz}, \text{ base grounded}$					
Emitter-base capacitance	C _{eb}	-	0.97	-	
$V_{\text{EB}} = 0.5 \text{ V}, f = 1 \text{ MHz}, \text{ collector grounded}$					
Noise figure	F				dB
$I_{C} = 25 \text{ mA}, V_{CE} = 3 \text{ V}, f = 1.8 \text{ GHz}, Z_{S} = Z_{Sopt}$		-	0.6	-	
$I_{C} = 25 \text{ mA}, V_{CE} = 3 \text{ V}, f = 6 \text{ GHz}, Z_{S} = Z_{Sopt}$		-	1.1	-	
Power gain, maximum stable ¹⁾	G _{ms}	-	21	-	dB
$I_{\rm C} = 60 \text{ mA}, \ V_{\rm CE} = 3 \text{ V}, \ Z_{\rm S} = Z_{\rm Sopt},$					
$Z_{L} = Z_{Lopt}$, $f = 1.8 \text{ GHz}$					
Power gain, maximum available ¹⁾	G _{ma}	-	11.5	-	dB
$I_{\rm C} = 60 \text{ mA}, \ V_{\rm CE} = 3 \text{ V}, \ Z_{\rm S} = Z_{\rm Sopt},$					
$Z_L = Z_{Lopt}, f = 6 \text{ GHz}$					
Transducer gain	$ S_{21e} ^2$				dB
$I_{\rm C} = 60$ mA, $V_{\rm CE} = 3$ V, $Z_{\rm S} = Z_{\rm L} = 50$ Ω ,					
f = 1.8 GHz		-	18	-	
$I_{\rm C} = 60$ mA, $V_{\rm CE} = 3$ V, $Z_{\rm S} = Z_{\rm L} = 50$ Ω ,					
f = 6 GHz		-	8	-	
Third order intercept point at output ²⁾	IP ₃	-	29.5	-	dBm
$V_{CE} = 3 \text{ V}, I_{C} = 60 \text{ mA}, f = 1.8 \text{ GHz},$					
$Z_{\rm S} = Z_{\rm L} = 50 \ \Omega$					
1dB Compression point at output	P _{-1dB}	-	16.5	-	
$I_{\rm C} = 60 \text{ mA}, \ V_{\rm CE} = 3 \text{ V}, \ Z_{\rm S} = Z_{\rm L} = 50 \ \Omega,$					
		1			1

 $^{^{1}}G_{\mathsf{ma}} = |S_{21e} / S_{12e}| \; (k - (k^2 - 1)^{1/2}), \; G_{\mathsf{ms}} = |S_{21e} / S_{12e}|$

²IP3 value depends on termination of all intermodulation frequency components.

Termination used for this measurement is 50Ω from 0.1 MHz to 6 GHz



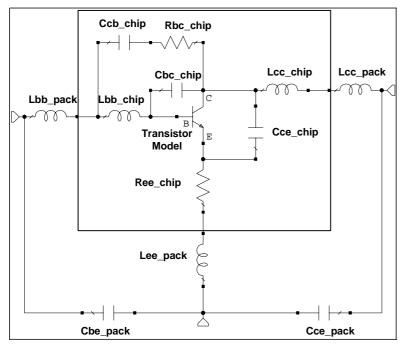
SPICE Parameter (Gummel-Poon Model, Berkley-SPICE 2G.6 Syntax):

Transistor Chip Data:

IS =	2.66 e-12	mA	BF =	753	-	NF =	1.015	-
VAF =	95	V	IKF =	292	mΑ	ISE =	1.54 e-11	mΑ
NE =	1.8	-	BR =	76	-	NR =	1	-
VAR =	1.33	V	IKR =	1.33	mA	ISC =	1 e-27	mΑ
NC =	2	-	RB =	1	Ω	IRB =	1 e15	Α
RBM =	0.9	Ω	RE =	20	$m\Omega$	RC =	0.9	Ω
CJE =	0.475	pF	VJE =	0.69	V	MJE =	0.085	-
TF =	0.0021	ns	XTF =	3	-	VTF =	2.1	V
ITF =	2540	mΑ	PTF =	0.5		CJC =	0.173	pF
VJC =	0.45	V	MJC =	0.31		XCJC =	0.01	-
TR =	1.2	ns	CJS =	0.325	pF	VJS =	0.65	V
MJS =	0.25	-	XTB =	-2.2	-	EG =	1.11	
XTI =	0.436	-	FC =	0.5		TNOM	25	°C
AF =	1	-	KF =	0	-			

All parameters are ready to use, no scalling is necessary.

Package Equivalent Circuit:



0.212 nΑ $L_{\rm bb_chip} =$ 0.07472 $L_{\rm cc\ chip} =$ nΗ 0.0184 $L_{\rm bb_pack} =$ nΗ nΗ $L_{\text{cc_pack}} =$ 0.277 nΗ 0.239 $L_{\text{ee}_\text{pack}} =$ 0.015 рF $C_{\rm bc\ chip} =$ 0.013 pF $C_{\text{cb_chip}} =$ 0.282 $C_{\text{ce_chip}} =$ pF 0.064 pF C_{be pack} = 0.0492 pF $C_{\text{ce_pack}} =$ 7 Ω $R_{\rm bc\ chip} =$ 0.566 Ω $R_{\text{ee chip}} =$ Valid up to 6GHz

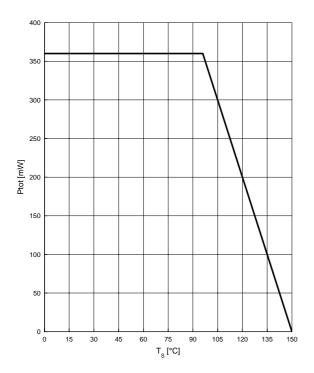
For examples and ready to use parameters please contact your local Infineon Technologies distributor or sales office to obtain a Infineon Technologies CD-ROM or see Internet: http://www.infineon.com

2007-04-26



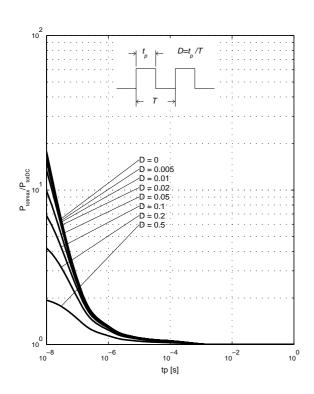
Total power dissipation $P_{tot} = f(T_S)$

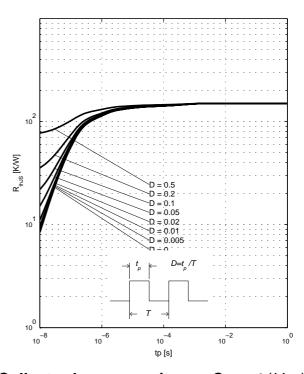
Permissible Puls Load $R_{thJS} = f(t_p)$



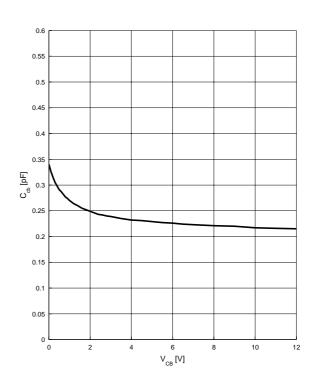
Permissible Pulse Load

$$P_{\text{totmax}}/P_{\text{totDC}} = f(t_{p})$$





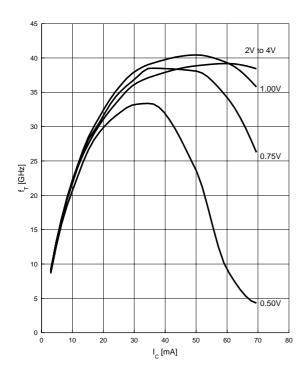
Collector-base capacitance $C_{cb} = f (V_{CB})$ f = 1 MHz





Transition frequency $f_T = f(I_C)$

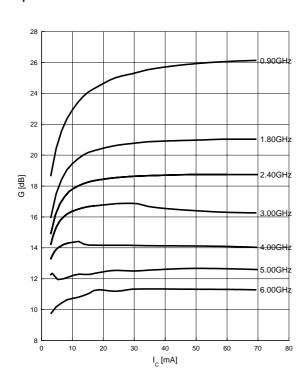
 V_{CE} = parameter, f = 1 GHz



Power gain G_{ma} , $G_{ms} = f(I_C)$

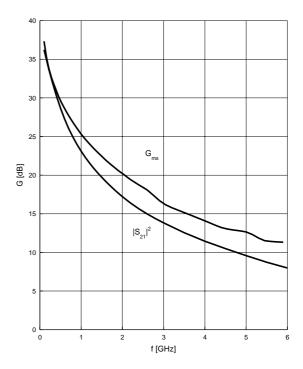
 $V_{CE} = 3 \text{ V}$

f = parameter



Power gain G_{ma} , $G_{ms} = f(f)$

 $V_{CE} = 3 \text{ V}, I_{C} = 60 \text{ mA}$

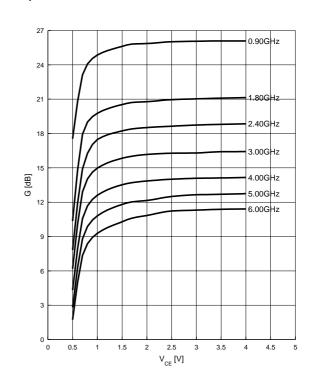


Power gain G_{ma} , $G_{ms} = f(V_{CE})$

 $I_{\rm C} = 60 \, {\rm mA}$

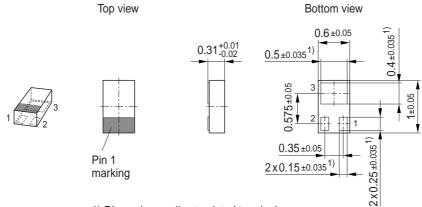
6

f = parameter





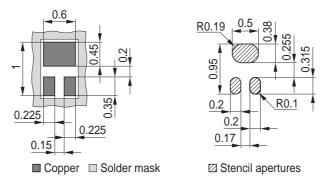
Package Outline



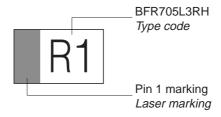
1) Dimension applies to plated terminal

Foot Print

For board assembly information please refer to Infineon website "Packages"

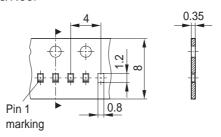


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 15.000 Pieces/Reel





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8 2007-04-26